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1. Name of conveying party(ies):
YU, Ji Hwan

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
Name: DongbuAnam Semiconductor Inc.
Internal Address: _____
Street Address: _____
891-10, Daechi-Dong
Kangnam-Ku
City: Seoul
Country: Republic of Korea Zip: _____
Additional name(s) & address(es) attached: Yes No

12921 U.S. PTO
11/319572



3. Nature of Conveyance:
 Assignment Merger
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Execution Date: December 29, 2005

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the new application is: December 29, 2005
A. Patent Application No.(s): ; filed
B. Patent No.(s): _____
Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: Song K. Jung
MCKENNA LONG & ALDRIDGE LLP
Internal Address: Atty. Dkt.: 10216.115.00-US
Street Address: _____
1900 K STREET, N.W.
City: WASHINGTON State: DC Zip: 20006

6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 3.41) \$ 40.00
 Enclosed
 Authorized to be charged to deposit account
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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
Mark R. Kresloff; Reg. No. 42,766
Name of Person Signing Mark R. Kresloff Signature December 29, 2005 Date
Total number of pages including cover sheet, attachments, and documents: 3

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PATENT
REEL: 017426 FRAME: 0116

Assignment of Application

WHEREAS, I (WE)	Ji Hwan YU		
			, respectively,
have invented certain new and useful improvements in:			
SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME			
for which an application for Letters Patent was executed on			
(Application No.		, Filed	
), and			
WHEREAS,	DongbuAnam Semiconductor Inc.		
(hereinafter referred to as "ASSIGNEE") having a place of business at:			
891-10, Daechi-Dong, Kangnam-Ku, Seoul, Korea			

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and Its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behalf of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and

enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of McKenna Long & Aldridge LLP, Attorneys at Law, 1900 K Street, N.W., Washington, D.C. 20006 the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: Dec. 29, 2005

유지환

(Signature of Inventor)

Ji Hwan YU

McKenna Long & Aldridge LLP
Attorneys At Law
1900 K Street, N.W.
Washington, D.C. 20006